

Die Characteristics**DIE DIMENSIONS:**

88 mils x 88 mils
2.24mm x 2.24mm

METALLIZATION:

Type: AlSiCu
Metal 1 Thickness: 6.75kÅ (Min), 8.25kÅ (Max)
Metal 2 Thickness: 9kÅ (Min), 11kÅ (Max)

GLASSIVATION:

Type: SiO₂
Thickness: 8kÅ ±1kÅ

DIE ATTACH:

Material: Silver Glass or JM7000 Polymer after 7/1/95

WORST CASE CURRENT DENSITY:

< 2.0 x 10⁵ A/cm²

BOND PAD SIZE:

> 4.3 mils x 4.3 mils
> 110µm x 110µm

Metallization Mask Layout

ACTS86MS



